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CLAIMS

1. A patch package characterized by comprising a laminated packaging material with a saturation hygroscopicity of 2-30 g/m² under atmosphere 5 conditions with a temperature of 25°C and a relative humidity of 75%, wherein a hygroscopic material layer composed of a first resin containing 20-40 wt% of an inorganic filler is situated between a moisture-permeable material layer composed of a second resin and having a moisture permeability of 40-120 g/m²/day and a screen material layer which blocks penetration of 10 moisture and light, and by being shaped into a pouch with said moisture-permeable material layer on the inside.

15 2. A patch package according to claim 1, wherein said first resin and said second resin are low density polyethylene, and said screen material layer comprises a metal foil and a high density polyethylene layer.

20 3. A patch package according to claim 2, wherein the thickness of said hygroscopic material layer is 20-40 µm,

the thickness of said moisture-permeable material layer is 5-15 µm,

25 the thickness of said high-density polyethylene layer composing said screen material layer is 10-30 µm

and

the thickness of said metal foil composing said screen material layer is 5-15 μm .

4. A patch package according to any one of
5 claims 1 to 3, wherein said patch package is hermetically sealed by heat sealing of said laminated packaging material, and

the heat seal strength is from 1.0 kg/25 mm to 5.0 kg/25 mm.

10 \rightarrow 5. A packaged patch characterized in that
a patch having a support and a pressure-sensitive adhesive composed mainly of a styrene-isoprene-styrene block copolymer laminated on said support is situated in a patch package according to any one of claims 1 to

15 \circlearrowleft 4, and
the total surface area of the interior of said patch package is 1.2-10 times the effective area of said patch.